

# CD4014B, CD4021B Types

## CMOS 8-Stage Static Shift Registers

High-Voltage Types (20-Volt Rating)

**CD4014B:**

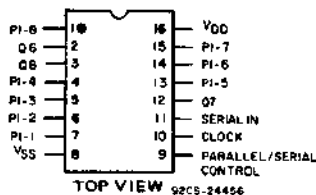
Synchronous Parallel or  
Serial Input/Serial Output

**CD4021B:**

Asynchronous Parallel Input or  
Synchronous Serial Input/Serial Output

■ CD4014B and CD4021B series types are 8-stage parallel- or serial-input/serial output registers having common CLOCK and PARALLEL/SERIAL CONTROL inputs, a single SERIAL data input, and individual parallel "JAM" inputs to each register stage. Each register stage is a D-type, master-slave flip-flop. In addition to an output from stage 8, "Q" outputs are also available from stages 6 and 7. Parallel as well as serial entry is made into the register synchronously with the positive clock line transition in the CD4014B. In the CD4021B serial entry is synchronous with the clock but parallel entry is asynchronous. In both types, entry is controlled by the PARALLEL/SERIAL CONTROL input. When the PARALLEL/SERIAL CONTROL input is low, data is serially shifted into the 8-stage register synchronously with the positive transition of the clock line. When the PARALLEL/SERIAL CONTROL input is high, data is jammed into the 8-stage register via the parallel input lines and synchronous with the positive transition of the clock line. In the CD4021B, the CLOCK input of the internal stage is "forced" when asynchronous parallel entry is made. Register expansion using multiple packages is permitted.

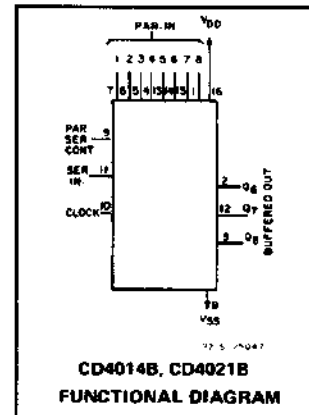
The CD4014B and CD4021B series types are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix), 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (M, M96, and NSR suffixes), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).



TERMINAL DIAGRAM  
CD4014B, CD4021B

### Features:

- Medium-speed operation . . . 12 MHz (typ.) clock rate at  $V_{DD}-V_{SS} = 10\text{ V}$
- Fully static operation
- 8 master-slave flip-flops plus output buffering and control gating
- 100% tested for quiescent current at 20 V
- Maximum input current of  $1\ \mu\text{A}$  at 18 V over full package-temperature range; 100 nA at 18 V and 25°C
- Noise margin (full package-temperature range) = 1 V at  $V_{DD} = 5\text{ V}$   
2 V at  $V_{DD} = 10\text{ V}$   
2.5 V at  $V_{DD} = 15\text{ V}$
- Standardized, symmetrical output characteristics
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"



### Applications:

- Parallel input/serial output data queuing
- Parallel to serial data conversion
- General-purpose register

RECOMMENDED OPERATING CONDITIONS AT  $T_A = 25^\circ\text{C}$ , Unless Otherwise Specified  
For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges.

CHARACTERISTIC	$V_{DD}$ (V)	LIMITS		UNITS	
		Min.	Max.		
Supply-Voltage Range ( $T_A = \text{Full Package-Temperature Range}$ )	—	3	18	V	
Clock Pulse Width, $t_W$	5	180	—	ns	
	10	80	—		
	15	50	—		
Clock Frequency, $f_{CL}$	5	—	3	MHz	
	10	—	6		
	15	—	8.5		
Clock Rise and Fall Time, $t_{rCL}, t_{fCL}$	5	—	15	$\mu\text{s}$	
	10	—	15		
	15	—	15		
Set-up Time, $t_s$ :	Serial Input (ref. to CL)	5	120	—	ns
		10	80	—	
		15	60	—	
	Parallel Inputs CD4014B (ref. to CL)	5	80	—	ns
		10	50	—	
		15	40	—	
Parallel Inputs CD4021B (ref. to P/S)	5	50	—	ns	
	10	30	—		
	15	20	—		
Parallel/Serial Control CD4014B (ref. to CL)	5	180	—	ns	
	10	80	—		
	15	60	—		
Parallel/Serial Pulse Width, $t_W$ (CD4021B)	5	160	—	ns	
	10	80	—		
	15	50	—		
Parallel/Serial Removal Time, $t_{REM}$ (CD4021B)	5	280	—	ns	
	10	140	—		
	15	100	—		

## CD4014B, CD4021B Types

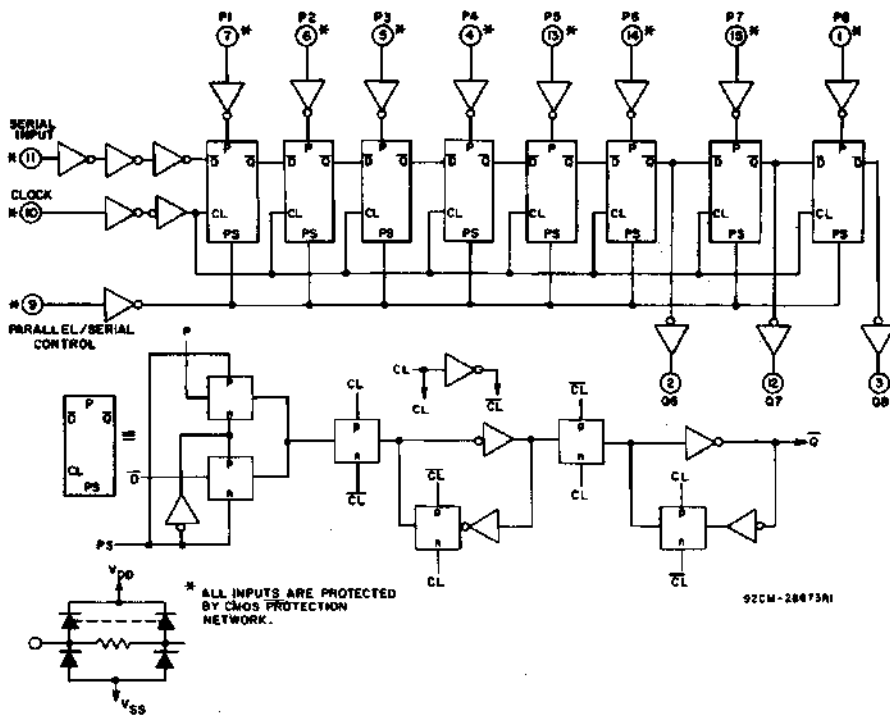


Fig. 1 - Logic diagram for CD4014B.

**TRUTH TABLE - CD4014B**

CL	SER IN	PAR SER CONTROL	PI-1	PI-n	Q1 (INTERNAL)	Qn
/	X	1	0	0	0	0
/	X	1	1	0	1	0
/	X	1	0	1	0	1
/	X	1	1	1	1	1
/	0	0	X	X	0	Q <sub>n-1</sub>
/	1	0	X	X	1	Q <sub>n-1</sub>
/	X	X	X	X	Q <sub>1</sub>	Q <sub>n</sub>

X - DON'T CARE CASE  
NC - NO CHANGE

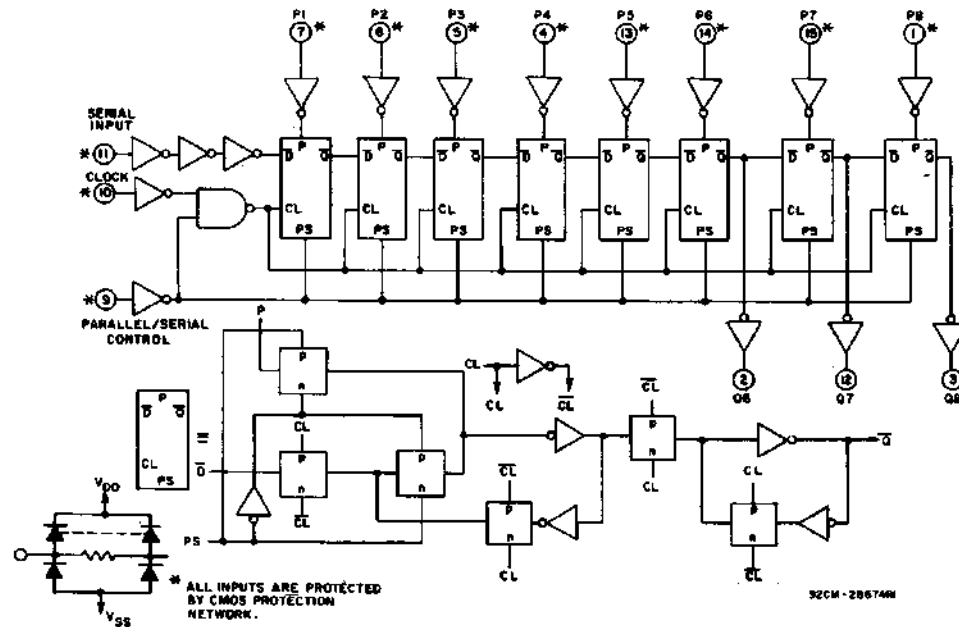


Fig. 2 - Logic diagram for CD4021B.

**TRUTH TABLE - CD4021B**

CL	Serial Input	Parallel/Ser Control	PS-1	PI-n	Q1 (Internal)	Qn
X	X	1	0	0	0	0
X	X	1	0	1	0	1
X	X	1	1	0	1	0
X	X	1	1	1	1	1
/	0	0	X	X	0	Q <sub>n-1</sub>
/	1	0	X	X	1	Q <sub>n-1</sub>
/	X	0	X	X	Q <sub>1</sub>	Q <sub>n</sub>

X - DON'T CARE CASE

# CD4014B, CD4021B Types

## MAXIMUM RATINGS, Absolute-Maximum Values:

DC SUPPLY-VOLTAGE RANGE, ( $V_{DD}$ ) Voltages referenced to $V_{SS}$ Terminal)	-0.5V to +20V
INPUT VOLTAGE RANGE, ALL INPUTS	-0.5V to $V_{DD} + 0.5V$
DC INPUT CURRENT, ANY ONE INPUT	$\pm 10\text{mA}$
POWER DISSIPATION PER PACKAGE ( $P_D$ ):	
For $T_A = -55^\circ\text{C}$ to $+100^\circ\text{C}$	500mW
For $T_A = +100^\circ\text{C}$ to $+125^\circ\text{C}$	Derate Linearly at 12mW/ $^\circ\text{C}$ to 200mW
DEVICE DISSIPATION PER OUTPUT TRANSISTOR	
FOR $T_A = \text{FULL PACKAGE-TEMPERATURE RANGE (All Package Types)}$	100mW
OPERATING-TEMPERATURE RANGE ( $T_A$ )	$-55^\circ\text{C}$ to $+125^\circ\text{C}$
STORAGE TEMPERATURE RANGE ( $T_{stg}$ )	$-65^\circ\text{C}$ to $+150^\circ\text{C}$
LEAD TEMPERATURE (DURING SOLDERING):	
At distance 1/16 $\pm$ 1/32 inch (1.59 $\pm$ 0.79mm) from case for 10s max	$+265^\circ\text{C}$

## STATIC ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	CONDITIONS			LIMITS AT INDICATED TEMPERATURES ( $^\circ\text{C}$ )							UNITS
	$V_O$ (V)	$V_{IN}$ (V)	$V_{DD}$ (V)	-55	-40	+85	+125	+25			
								Min.	Typ.	Max.	
Quiescent Device Current, $I_{DD}$ Max.	-	0.5	5	5	5	150	150	-	0.04	5	$\mu\text{A}$
	-	0.10	10	10	10	300	300	-	0.04	10	
	-	0.15	15	20	20	600	600	-	0.04	20	
	-	0.20	20	100	100	3000	3000	-	0.08	100	
Output Low (Sink) Current, $I_{OL}$ Min.	0.4	0.5	5	0.64	0.61	0.42	0.36	0.51	1	-	mA
	0.5	0.10	10	1.6	1.5	1.1	0.9	1.3	2.6	-	
	1.5	0.15	15	4.2	4	2.8	2.4	3.4	6.8	-	
Output High (Source) Current, $I_{OH}$ Min.	4.6	0.5	5	-0.64	-0.61	-0.42	-0.36	-0.51	-1	-	mA
	2.5	0.5	5	-2	-1.8	-1.3	-1.15	-1.6	-3.2	-	
	9.5	0.10	10	-1.6	-1.5	-1.1	-0.9	-1.3	-2.6	-	
	13.5	0.15	15	-4.2	-4	-2.8	-2.4	-3.4	-6.8	-	
Output Voltage: Low-Level, $V_{OL}$ Max.	-	0.5	5	0.05				-	0	0.05	V
	-	0.10	10	0.05				-	0	0.05	
	-	0.15	15	0.05				-	0	0.05	
Output Voltage: High-Level, $V_{OH}$ Min.	-	0.5	5	4.95				4.95	5	-	V
	-	0.10	10	9.95				9.95	10	-	
	-	0.15	15	14.95				14.95	15	-	
Input Low Voltage, $V_{IL}$ Max.	0.5, 4.5	-	5	1.5				-	-	1.5	V
	1.9	-	10	3				-	-	3	
	1.5, 13.5	-	15	4				-	-	4	
Input High Voltage, $V_{IH}$ Min.	0.5, 4.5	-	5	3.5				3.5	-	-	V
	1.9	-	10	7				7	-	-	
	1.5, 13.5	-	15	11				11	-	-	
Input Current $I_{IN}$ Max.	-	0.18	18	$\pm 0.1$	$\pm 0.1$	$\pm 1$	$\pm 1$	-	$\pm 10^{-5}$	$\pm 0.1$	$\mu\text{A}$

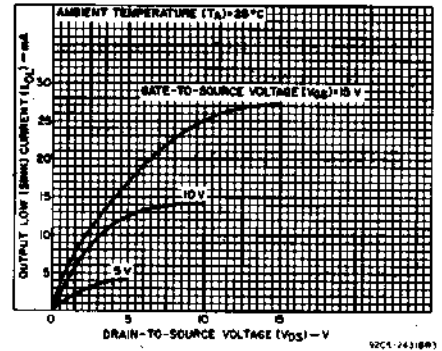


Fig. 3 - Typical output low (sink) current characteristics.

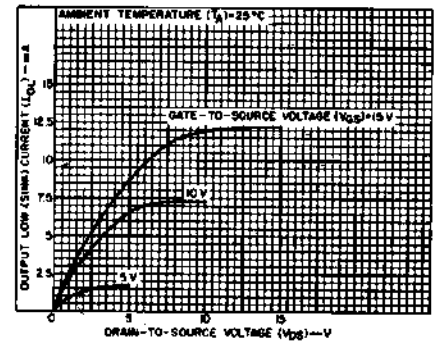


Fig. 4 - Minimum output low (sink) current characteristics.

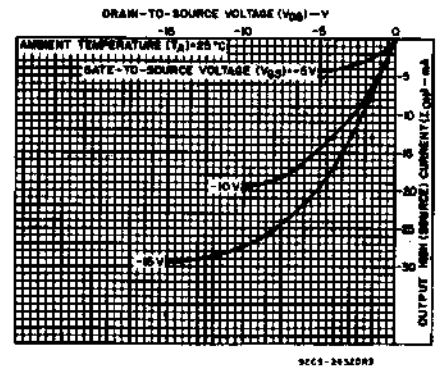


Fig. 5 - Typical output high (source) current characteristics.

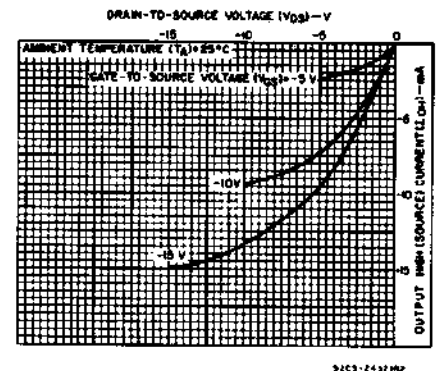


Fig. 6 - Minimum output high (source) current characteristics.

3  
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HIGH VOLTAGE ICs

## CD4014B, CD4021B Types

**DYNAMIC ELECTRICAL CHARACTERISTICS** at  $T_A=25^\circ\text{C}$ , Input  $t_r, t_f=20\text{ ns}$ ,  $C_L=50\text{ pF}$ ,  $R_L=200\text{ K}\Omega$

CHARACTERISTIC	TEST CONDITIONS	LIMITS			UNITS
		V <sub>DD</sub> (V)	Min.	Typ.	
Propagation Delay Time, $t_{PLH}, t_{PHL}$	5	—	160	320	ns
	10	—	80	160	
	15	—	60	120	
Transition Time, $t_{THL}, t_{TLH}$	5	—	100	200	ns
	10	—	50	100	
	15	—	40	80	
Maximum Clock Input Frequency, $f_{CL}$	5	3	6	—	MHz
	10	6	12	—	
	15	8.5	17	—	
Minimum Clock Pulse Width, $t_{WP}$	5	—	90	180	ns
	10	—	40	80	
	15	—	25	50	
Clock Rise and Fall Time, $t_r, t_f$	5	—	—	15	$\mu\text{s}$
	10	—	—	15	
	15	—	—	15	
Minimum Set-up Time, $t_s$ : Serial Input (ref. to CL)	5	—	60	120	ns
	10	—	40	80	
	15	—	30	60	
Parallel Inputs CD4014B (ref. to CL)	5	—	40	80	ns
	10	—	25	50	
	15	—	20	40	
Parallel Inputs CD4021B (ref. to P/S)	5	—	25	50	ns
	10	—	15	30	
	15	—	10	20	
Parallel/Serial Control CD4014B (ref. to CL)	5	—	90	180	ns
	10	—	40	80	
	15	—	30	60	
Minimum Hold Time, $t_H$ : Serial In, Parallel In, Parallel/Serial Control	5	—	—	0	ns
	10	—	—	0	
	15	—	—	0	
Minimum P/S Pulse Width, $t_{WH}$ (CD4021B)	5	—	80	160	ns
	10	—	40	80	
	15	—	25	50	
Minimum P/S Removal Time, $t_{REM}$ CD4021B (ref. to CL)	5	—	140	280	ns
	10	—	70	140	
	15	—	50	100	
Average Input Capacitance, $C_I$	Any Input	—	5	7.5	$\mu\text{F}$

\* If more than one unit is cascaded  $t_r, t_f$  should be made less than or equal to the sum of the transition time and the fixed propagation delay of the output of the driving stage for the estimated capacitive load.

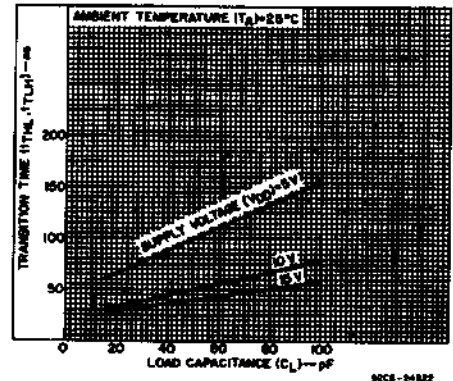


Fig. 7— Typical transition time as a function of load capacitance.

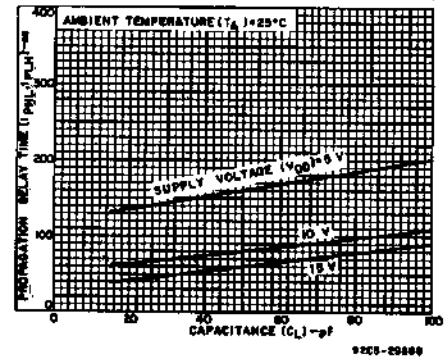


Fig. 8— Typical propagation delay time as a function of load capacitance.

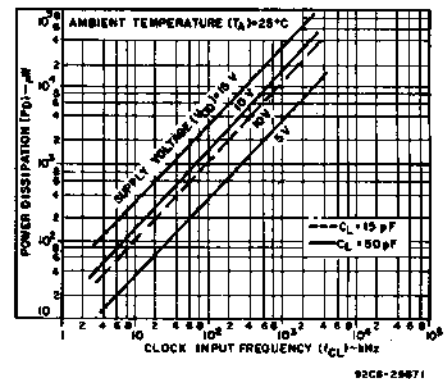


Fig. 9— Typical dynamic power dissipation as a function of clock input frequency.

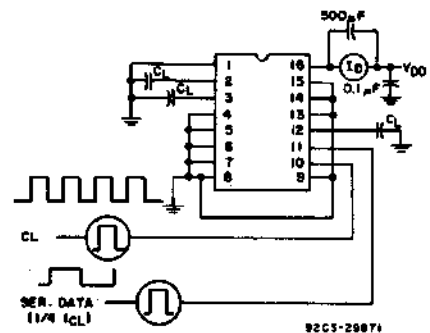


Fig. 10— Dynamic power dissipation test circuit.

# CD4014B, CD4021B Types

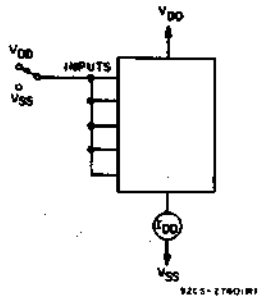


Fig. 11 - Quiescent device current test circuit.

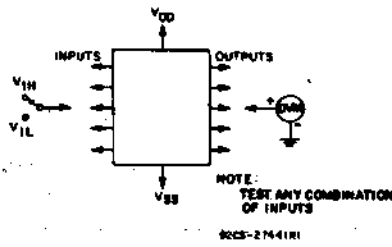


Fig. 12 - Input voltage test circuit.

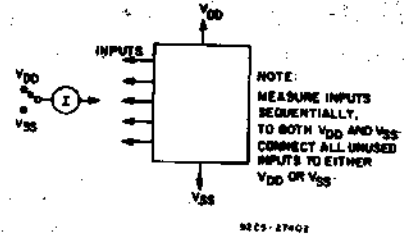
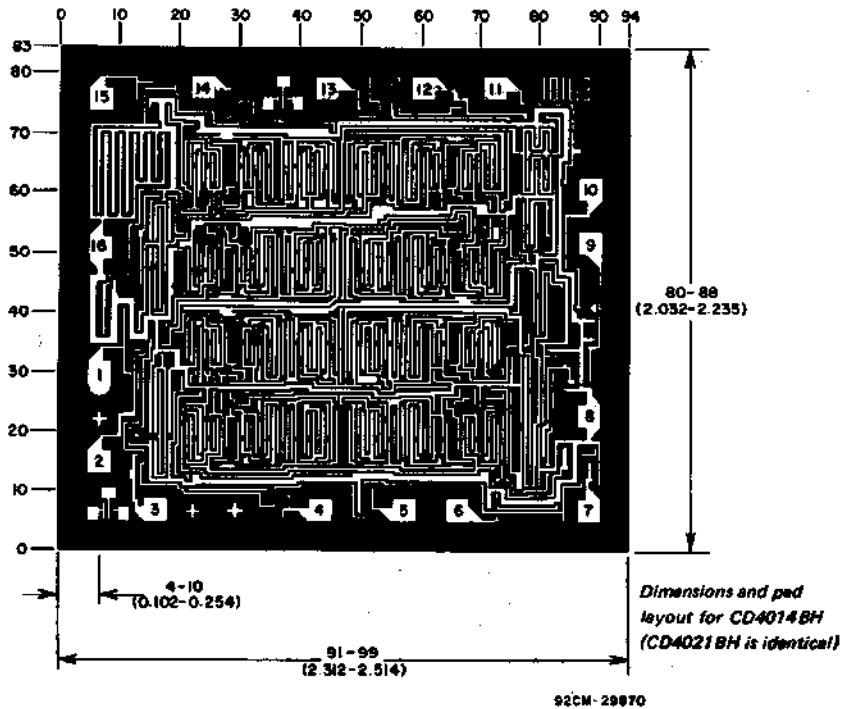


Fig. 13 - Input current test circuit.



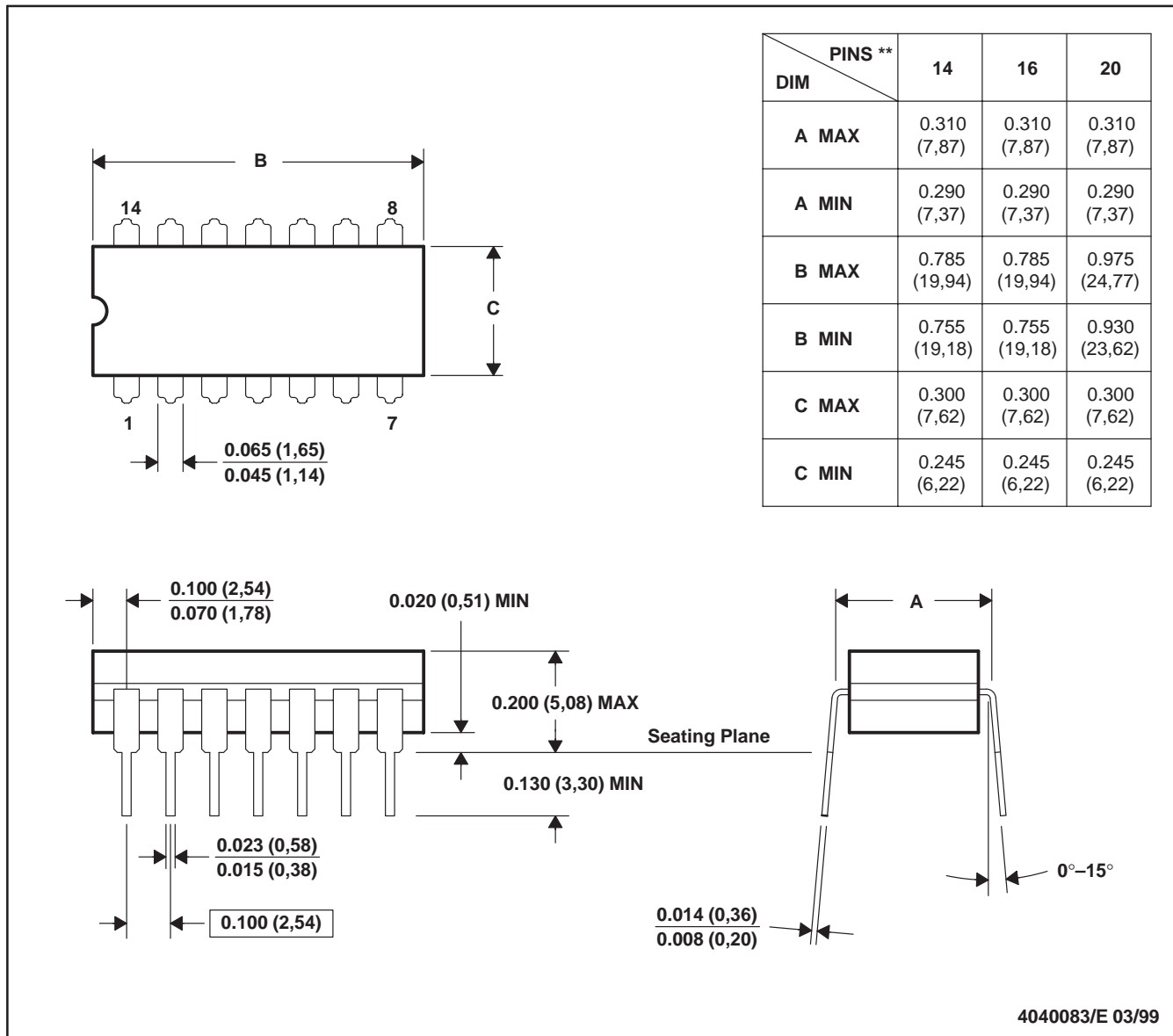
Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils ( $10^{-3}$  inch).

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J (R-GDIP-T\*\*)

CERAMIC DUAL-IN-LINE

14 LEADS SHOWN

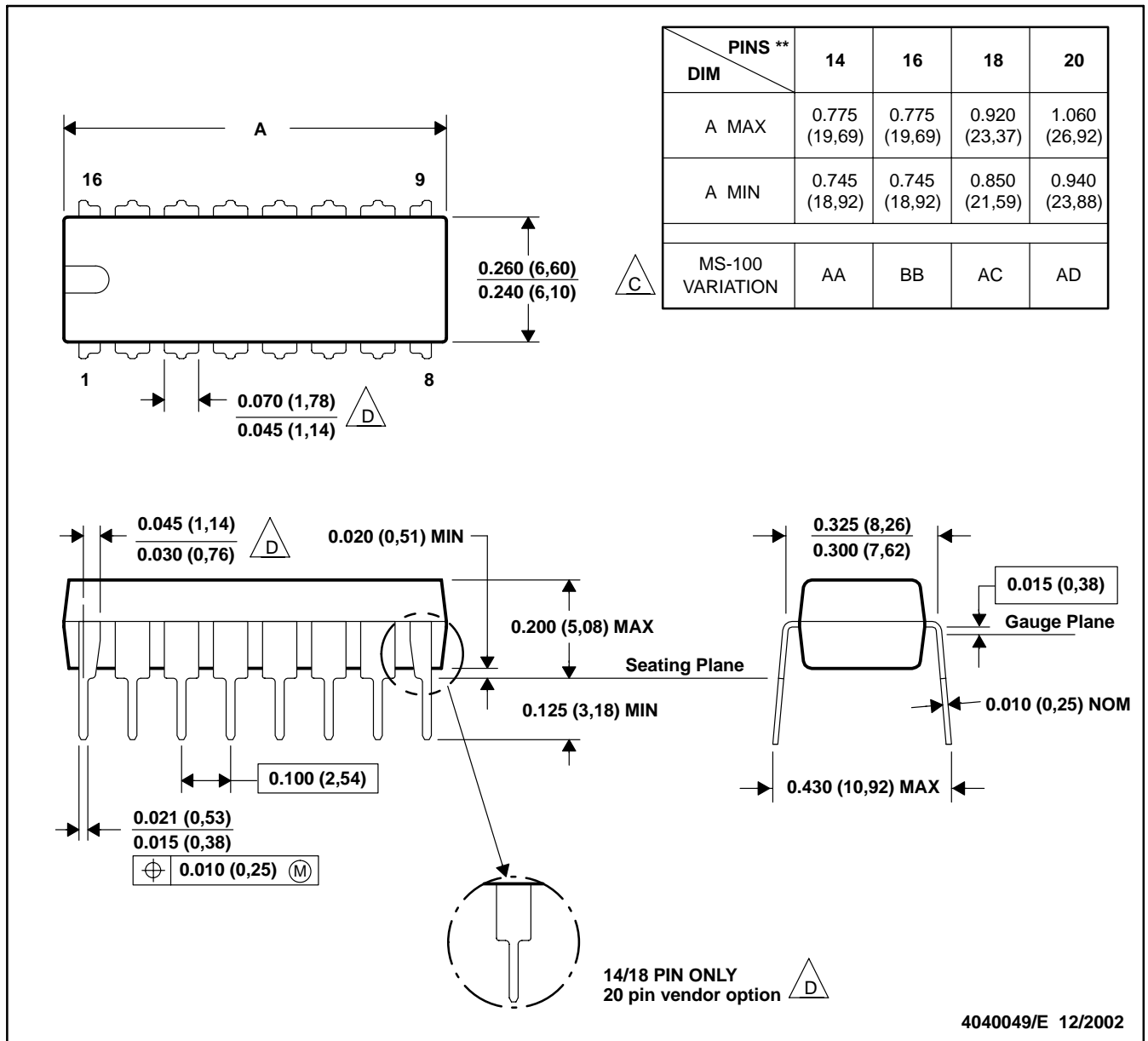


- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. This package is hermetically sealed with a ceramic lid using glass frit.  
 D. Index point is provided on cap for terminal identification.  
 E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, and GDIP1-T20

N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).  
 D The 20 pin end lead shoulder width is a vendor option, either half or full width.

D (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

8 PINS SHOWN

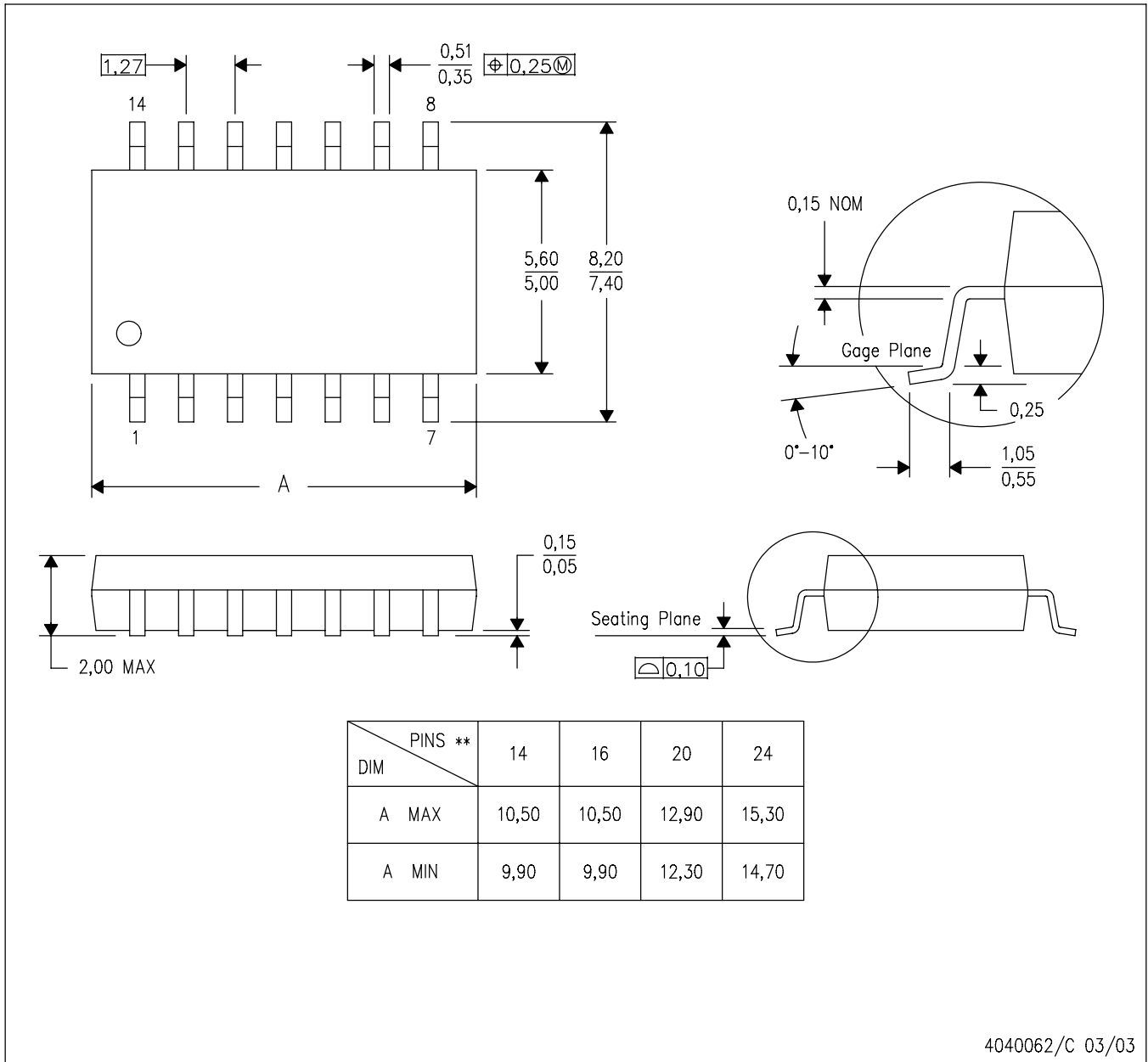


- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).  
 D. Falls within JEDEC MS-012



NS (R-PDSO-G\*\*)   
 14-PIN SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

PW (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

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